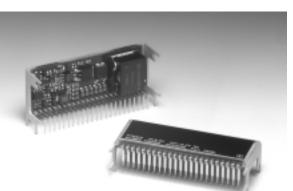
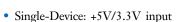
Not Recommended For New Designs

PT6910 Series

12 Watt 5V/3.3V Input Plus to Minus Voltage Converter



Patent pending on package assembly



EXCALIBUR

- Remote Sense
- +5V & +3.3V Input Voltage
- Adjustable Output Voltage
- 23-pin Space-Saving Package
- Solderable Copper Case

The PT6910 series is a series of high performance 12 watt, plus to minus voltage convertors that are designed to power the latest ECL (-5.2V) and

GaAs (-2.0V) ICs from an existing +5.0V or +3.3V source.

These regulators are similar to the popular PT6900 series with the added feature of Power Trends' unique solderable copper case.

Power Trends Products

from Texas Instruments

SLTS113

(Revised 11/30/2000)

A 330µF electrolytic capacitor is required on both the input and output for proper operation. Also note that this product does not include shortcircuit protection.

Pin-Out Information

Standard Application +V_{IN} \xrightarrow{PT} PT6910 \xrightarrow{I} \xrightarrow{P} \xrightarrow{P}

Specifications

Pin	Function	Pin	Function
1	Do not connect	13	GND
2	V _{out} Adjust	14	GND
3	Vin	15	GND
4	Vin	16	Vout
5	Vin	17	Vout
6	Vin	18	Vout
7	Vin	19	Vout
8	Remote Sense GND	20	Vout
9	GND	21	Vout
10	GND	22	Remote Sense Vout
11	GND	23	Do not connect
12	GND	-	

Ordering Information

+5V Input	+3.3V Input	Vout
0 0	PT6914□ PT6915□	

PT Series Suffix (PT1234X)

Case/Pin Configuration

Comparation	
Vertical Through-Hole	Ν
Horizontal Through-Hole	Α
Horizontal Surface Mount	С
(For dimensions and PC be see Package Styles 1300 an	oard layout 1d 1310.)

Characteristics			P	T6910 SERI	ES	
(T _a = 25°C unless noted)	Symbols	Conditions	Min	Тур	Max	Units
Output Current	Io	$T_a = +25^{\circ}C$, natural convection				
			$\begin{array}{c} 0.1 \ (1) \\ 0.1 \ (1) \end{array}$	_	6.0 (2) 3.5 (2)	А
		$V_{in} = 3.3V$ $V_o = -2.0V$ $V_o = -5.2V$	$\begin{array}{c} 0.1 \ (1) \\ 0.1 \ (1) \end{array}$	_	5.0 (2) 2.5 (2)	A A
Input Voltage Range		$0.1A \le I_o \le I_{max}$ PT6911 PT6912/PT6913	4.5	_	5.5	
		PT6914/PT6915	3.1	—	3.6	\mathbf{V}
Output Voltage Tolerance	ΔV_{o}	Nominal V _{in} , $I_o = I_{max}$ $0^{\circ}C \le T_a \le +60^{\circ}C$	$V_{\rm o}\!-\!0.05$	_	V_{o} + 0.05	V
Output Adjust Range	Vo	Pin 14 to V_0 or GND $V_0 = -2.0V$	-1.4	_	-4.4	
		$V_o = -5.2V$	-2.7	—	-6.5	\mathbf{V}
		V _o =-1.5V	-1.2	_	-3.4	
Line Regulation	Reg _{line}	Over V _{in} range, I _o =I _{max}	—	±0.5	±1.0	%
Load Regulation	Regload	V_{in} =V _{nom} , $0.1 \le I_o \le I_{max}$	_	±0.5	±1.0	%
V _o Ripple/Noise	V_n	$V_{in} = V_{nom}, I_o = I_{max}$ $V_o = -1.5V/-2.0V$ $V_o = -5.2V$	_	40 50	_	mV
Transient Response with C _{out} = 330μF	${f t_{tr}} {f V_{os}}$	I_o step between $0.5 x I_{max}$ and I_{max} V_o over/undershoot	_	200 200	_	μSec mV
Efficiency	η			65 70 77		%
		V_{in} = +3.3V, I_o =0.5x I_{max} Vo = -2.0V Vo = -5.2V	_	67 75	_	%
Switching Frequency	$f_{ m o}$	Over V _{in} and I _o ranges	500	_	600	kHz
Absolute Maximum Operating Temperature Range	T _a		0	_	+85 (2)	°C
Recommended Operating Temperature Range	Ta	Over V _{in} Range	0		+60	°C
Storage Temperature	Ts		-40	_	+125	°C
Weight	_	Vertical/Horizontal		26	_	grams

Notes: (1) ISR-will operate down to no load with reduced specifications.

(2) See Safe Operating Area curves, or consult the factory for the appropriate derating.

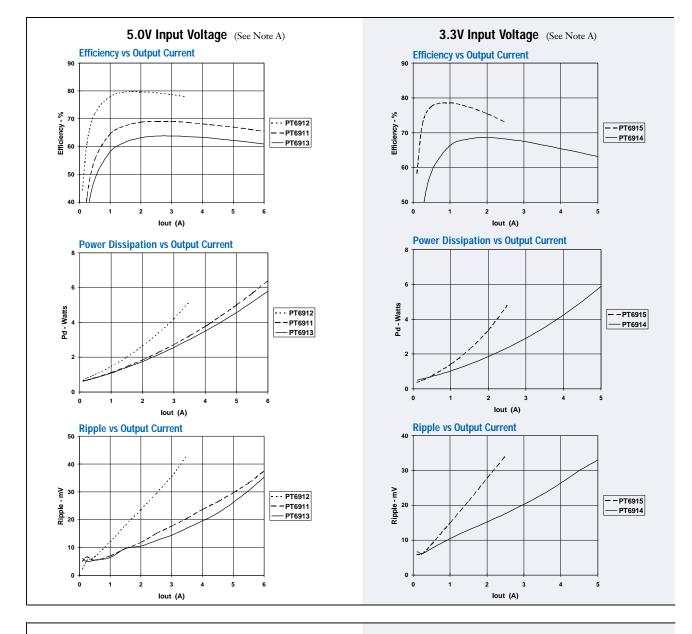


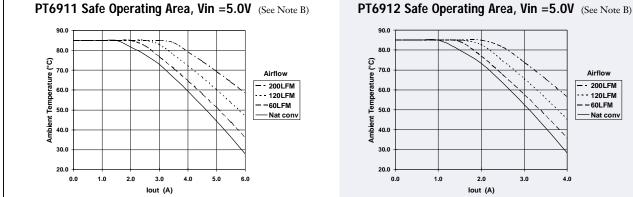


Typical Characteristics

12 Watt 5V/3.3V Input Plus to Minus Voltage Converter

PT6910 Series





Note A: All data listed in the above graphs has been developed from actual products tested at 25°C. This data is considered typical data for the DC-DC Converter. **Note B:** SOA curves represent the condition at which internal com-ponents are at or below manufacturere's maximum operating temperature.

🐺 Texas Instruments

2.0

lout (A)

3.0

4.0

Airflow

- 200LFM

-- 120LFM - 60LFM

Nat conv

Power Trends Products

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Adjusting the Output Voltage of the PT6900/PT6910 Positive to Negative Converter Series

The negative output voltage of the Power Trends PT6900 Series ISRs may be adjusted higher or lower than the factory trimmed pre-set voltage with the addition of a single external resistor. Table 1 gives the allowable adjustment range for each model in the series as V_a (min) and V_a (max).

Adjust Up: An increase in the output voltage is obtained by adding a resistor R2, between pin 2 (V_o adjust) and pin 8 (Remote Sense GND).

Adjust Down: Add a resistor (R1), between pin 2 (V_o adjust) and pin 22 (Remote Sense V_o).

Refer to Figure 1 and Table 2 for both the placement and value of the required resistor, either (R1) or R2 as appropriate.

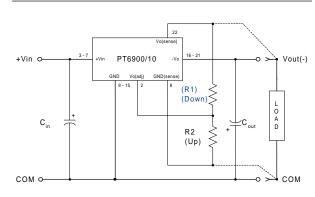
Notes:

- Only a single 1% resistor is required in either the (R1) or R2 location. Do not use (R1) and R2 simultaneously. Place the resistor as close to the ISR as possible.
- 2. Never connect capacitors from V_o adjust to either GND, V_{out} , or the Sense pins. Any capacitance added to the V_o adjust pin will affect the stability of the ISR.
- 3. If the sense pins are not being used, the resistors (R1) and R2 can be connected to V_{out} and GND respectively.
- 4. An increase in the output voltage must be accompanied by a corresponding reduction in the maximum output current. The revised maximum output current must be reduced to the equivalent of 12Watts.

i.e.
$$I_{out}$$
 (max) = $\frac{12}{V_a}$ Adc,

where V_{a} is the adjusted output voltage.





The respective values of (R1) [adjust down], and R2 [adjust up], can also be calculated using the following formulas.

$$(R1) = \frac{24.9 (V_a - V_r)}{(V_o - V_a)} - R_s k\Omega$$

$$R2 = \frac{24.9 V_r}{(V_a - V_o)} - R_s \qquad k\Omega$$

Where:

Vo = Original output voltage

- V_a = Adjusted output voltage
- V_r = Reference voltage in Table 1
- R_s = The resistance given in Table 1

Series Pt #			
5.0V Bus	PT6903/13	PT6901/11	PT6902/12
3.3V Bus		PT6904/14	PT6905/15
V _o (nom)	-1.5V	-2.0V	-5.2V
V _a (min)	-1.2V	-1.4V	-2.7V
Va (max)	-3.4V	-4.5V	-6.5V
Vr	-1.0V	-1.0V	-0.92V
Rs (kΩ)	12.7	10.0	17.4



PT6900/6910 Series

Table 2

Series Pt #			
5.0V Bus	PT6903/13	PT6901/11	PT6902/12
3.3V Bus		PT6904/14	PT6905/15
l _o (nom)	-1.5Vdc	-2.0Vdc	-5.2Vdc
la (req'd)			
-1.2	(3.9)kΩ		
-1.3	(24.7)kΩ		
-1.4	(86.9)kΩ	(6.6)kΩ	
-1.5		(14.9)kΩ	
-1.6	236.0kΩ	(27.4)kΩ	
-1.7	112.0kΩ	(48.1)kΩ	
-1.8	70.3kΩ	(89.6)kΩ	
-1.9	49.6kΩ	(214.0)kΩ	
-2.0	37.1kΩ		
-2.1	28.8kΩ	239.0kΩ	
-2.2	22.9kΩ	115.0kΩ	
-2.3	18.4kΩ	73.0kΩ	
-2.4	15.0kΩ	52.3kΩ	
-2.5	12.2kΩ	39.8kΩ	
-2.6	9.9kΩ	31.5kΩ	
-2.7	8.1kΩ	25.6kΩ	(0.3)kΩ
-2.8	6.5kΩ	21.1kΩ	(2.1)kΩ
-2.9	5.1kΩ	17.7kΩ	(4.0)kΩ
-3.0	3.9kΩ	14.9kΩ	(6.1)kΩ
-3.1	2.9kΩ	12.6kΩ	(8.5)kΩ
-3.2	2.0kΩ	10.8kΩ	(11.0)kΩ
-3.3	1.1kΩ	9.2kΩ	(13.8)kΩ
-3.4	0.4kΩ	7.8kΩ	(16.9)kΩ
-3.5		6.6kΩ	(20.4)kΩ
-3.6		5.6kΩ	(24.3)kΩ
-3.7		4.7kΩ	(28.7)kΩ
-3.8		3.8kΩ	(33.8)kΩ

5.0V Bus	PT6901/11	PT6902/12	
3.3V Bus	PT6904/14	PT6905/15	
V _o (nom)	-2.0Vdc	-5.2Vdc	
Va (req′d)			
-3.9	3.1kΩ	(39.7)kΩ	
-4.0	2.5kΩ	(46.5)kΩ	
-4.1	1.9kΩ	(54.6)kΩ	
-4.2	1.3kΩ	(64.3)kΩ	
-4.3	$0.8 \mathrm{k}\Omega$	(76.1)kΩ	
-4.4	0.4kΩ	(90.9)kΩ	
-4.5	0.0kΩ	(106.0)kΩ	
-4.6		(135.0)kΩ	
-4.7		(171.0)kΩ	
-4.8		(224.0)kΩ	
-4.9		(313.0)kΩ	
-5.0		(491.0)kΩ	
-5.1		(1020.0)kΩ	
-5.2			
-5.3		212.0kΩ	
-5.4		97.1kΩ	
-5.5		59.0kΩ	
-5.6		39.9kΩ	
-5.7		28.4kΩ	
-5.8		20.8kΩ	
-5.9		15.3kΩ	
-6.0		11.2kΩ	
-6.1		8.1kΩ	
-6.2		5.5kΩ	
-6.3		3.4kΩ	
-6.4		1.7kΩ	
-6.5		0.2kΩ	

R1 = (Blue)

R2 = Black

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PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Samples
	(1)		Drawing			(2)		(3)	(Requires Login)
PT6911A	LIFEBUY	SIP MODULE	ELA	23	10	TBD	Call TI	Level-1-215C-UNLIM	
PT6911N	OBSOLETE	SIP MODULE	ELD	23		TBD	Call TI	Call TI	
PT6912A	LIFEBUY	SIP MODULE	ELA	23	10	TBD	Call TI	Level-1-215C-UNLIM	
PT6912C	LIFEBUY	SIP MODULE	ELC	23	10	TBD	Call TI	Level-3-215C-168HRS	
PT6912N	LIFEBUY	SIP MODULE	ELD	23	10	TBD	Call TI	Level-1-215C-UNLIM	
PT6913C	LIFEBUY	SIP MODULE	ELC	23	10	TBD	Call TI	Level-3-215C-168HRS	
PT6914C	LIFEBUY	SIP MODULE	ELC	23	10	TBD	Call TI	Level-3-215C-168HRS	
PT6915A	LIFEBUY	SIP MODULE	ELA	23	10	TBD	Call TI	Level-1-215C-UNLIM	
PT6915C	LIFEBUY	SIP MODULE	ELC	23	10	TBD	Call TI	Level-3-215C-168HRS	

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

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Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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